Vishay Semiconductors

Thyristor High Voltage, Phase Control SCR, 40 A



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PRIMARY CHARACTERISTICS								
I _{T(AV)} 35 A								
V _{DRM} /V _{RRM}	1600 V							
V _{TM}	1.45 V							
I _{GT}	150 mA							
TJ	-40 °C to +125 °C							
Package	TO-247AC 3L							
Circuit configuration	Single SCR							

FEATURES

- High voltage (up to 1600 V)
- Designed and qualified according to JEDEC[®]-JESD 47
- 125 °C max. operating junction temperature
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

• Typical usage is in input rectification crowbar (soft start) and AC switch in motor control, UPS, welding and battery charge

DESCRIPTION

The VS-40TPS16... high voltage series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 125 °C junction temperature.

MAJOR RATINGS AND CHARACTERISTICS									
PARAMETER	TEST CONDITIONS	VALUES	UNITS						
I _{T(AV)}	Sinusoidal waveform	35	А						
I _{RMS}		55	A						
V _{RRM} /V _{DRM}		1600	V						
I _{TSM}		500	A						
V _T	40 A, T _J = 25 °C	1.45	V						
dV/dt		1000	V/µs						
dl/dt		100	A/µs						
TJ		-40 to +125	°C						

VOLTAGE RATINGS			
PART NUMBER	V _{RRM} /V _{DRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM} /I _{DRM} AT 125 °C mA
VS-40TPS16-M3	1600	1700	10



HALOGEN

FREE

VS-40TPS16-M3



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ABSOLUTE MAXIMUM RATINGS									
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS				
Maximum average on-state current	I _{T(AV)}	$T_C = 79 \ ^{\circ}C$, 180° conduction half sine wa	ive	35					
Maximum continuous RMS on-state current as AC switch	I _{T(RMS)}		55	А					
Maximum peak, one-cycle	L	10 ms sine pulse, rated V_{RRM} applied		420					
non-repetitive surge current	I _{TSM}	10 ms sine pulse, no voltage reapplied		500					
Maximum I ² t for fusing	l ² t	10 ms sine pulse, rated V_{RRM} applied	Initial T _J = T _J maximum	880	A ² s				
Maximum 1-t for fusing	1-1	10 ms sine pulse, no voltage reapplied	1250	A-S					
Maximum I²√t for fusing	l²√t	t = 0.1 to 10 ms, no voltage reapplied	12 500	A²√s					
Low level value of threshold voltage	V _{T(TO)1}		1.02	v					
High level value of threshold voltage	V _{T(TO)2}	T.I = 125 °C		1.23	v				
Low level value of on-state slope resistance	r _{t1}	1j = 125 0		9.74	mΩ				
High level value of on-state slope resistance	r _{t2}			7.50	1115.2				
Maximum peak on-state voltage	V_{TM}	110 A, T _J = 25 °C		1.85	V				
Maximum rate of rise of turned-on current	dl/dt	$T_J = 25 \ ^{\circ}C$		100	A/µs				
Maximum holding current	Ι _Η	Anode supply = 6 V, resistive load, initial	200						
Maximum latching current	١L	Anode supply = 6 V, resistive load, $T_J = 25 \degree C$			mA				
Maximum reverse and direct leakage current	/	$T_J = 25 \text{ °C}$ $V_B = \text{rated } V_{BBM}/\Lambda$	·	0.5	ШA				
waximum reverse and direct leakage current	I _{RRM} /I _{DRM}	$T_{\rm J} = 125 \ ^{\circ}{\rm C}$	DRM	10					
Maximum rate of rise of off-state voltage	dV/dt	$T_{\rm J}$ = $T_{\rm J}$ maximum, linear to 80 % $V_{\rm DRM},$ I	1000	V/µs					

TRIGGERING									
PARAMETER	SYMBOL	ТІ	TEST CONDITIONS						
Maximum peak gate power	P _{GM}								
Maximum average gate power	P _{G(AV)}			2.5	W				
Maximum peak gate current	I _{GM}			2.5	А				
Maximum peak negative gate voltage	- V _{GM}			10					
Maximum required DC gate		T _J = - 40 °C		4.0	V				
Maximum required DC gate voltage to trigger	V _{GT}	T _J = 25 °C	Anode supply = 6 V resistive load	2.5					
voluge to trigger		T _J = 125 °C		1.7					
		T _J = - 40 °C		270	mA				
Maximum required DC gate current to trigger		T _J = 25 °C	Anode supply = 6 V resistive load	150					
Maximum required DO gate current to trigger	I _{GT}	T _J = 125 °C		80					
		$T_{\rm J} = 25 ^{\circ}{\rm C}$, for 40	40						
Maximum DC gate voltage not to trigger	V_{GD}			0.25	V				
Maximum DC gate current not to trigger	I _{GD}	T _J = 125 °C, V _{DRM}	6	mA					

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THERMAL AND MECHANICAL SPECIFICATIONS									
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum junction and storage temperature range		T _J , T _{Stg}		-40 to 125	°C				
Maximum thermal resistance, junction to case		R _{thJC}	R _{thJC} DC operation						
Maximum thermal resistance, junction to ambient		R _{thJA}		40	°C/W				
Maximum thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.2					
Approximate weight				6	g				
Approximate weight				0.21	oz.				
Mounting torque	minimum			6 (5)	kgf · cm				
Mounting torque	maximum			12 (10)	(lbf ⋅ in)				
Marking device			Case style TO-247AC 3L	40TF	PS16				

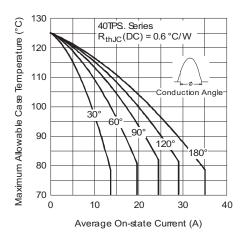


Fig. 1 - Current Rating Characteristics

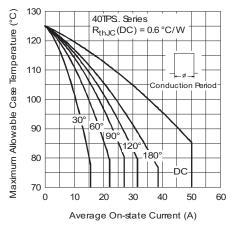


Fig. 2 - Current Rating Characteristics

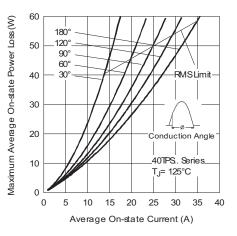


Fig. 3 - On-State Power Loss Characteristics

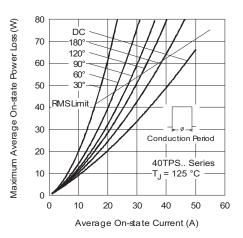
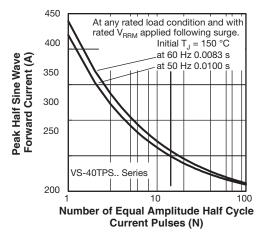


Fig. 4 - On-State Power Loss Characteristics

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Fig. 5 - Maximum Non-Repetitive Surge Current

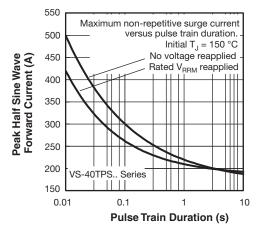


Fig. 6 - Maximum Non-Repetitive Surge Current

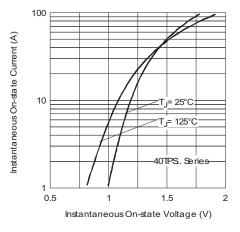


Fig. 7 - On-State Voltage Drop Characteristics

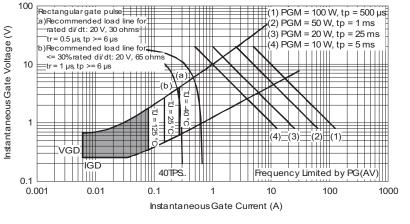


Fig. 8 - Gate Characteristics

VS-40TPS16-M3

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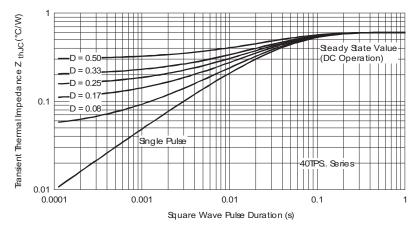


Fig. 9 - Thermal Impedance Z_{thJC} Characteristics

ORDERING INFORMATION TABLE

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SHAY

Device code	VS-	40	т	Р	S	16	-M3
		2	(3)	(4)	(5)	6	(7)
	1 - 2 - 3 - 4 - 5 -	 Visł Cur Circ T = Pac P = Typ 	nay Serr rent rati cuit conf thyristo kage: TO-247 e of silio	niconduo ng (40 = figuratio r AC 3L	etors pro	oduct	
	6 - 7 -	Envi	ronmen	ng (16 = tal digit: jen-free,		,	int, and

ORDERING INFORMATION (Example)									
PREFERRED P/N	ERRED P/N QUANTITY PER T/R MINIMUM ORDER QUANTITY PACKAGING DESCRIPTIO								
VS-40TPS16-M3	25	500	Antistatic plastic tubes						

LINKS TO RELATED DOCUMENTS						
Dimensions www.vishay.com/doc?96138						
Part marking information	www.vishay.com/doc?95007					

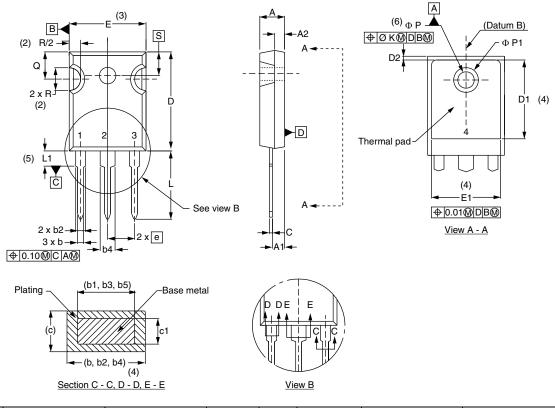
Revision: 26-Feb-2019 Document Number: 94389 For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000





TO-247AC - 50 mils L/F

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INC	HES	NOTES	NOTES		MILLIN	IETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES		SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.65	5.31	0.183	0.209			D2	0.51	1.35	0.020	0.053	
A1	2.21	2.59	0.087	0.102			E	15.29	15.87	0.602	0.625	3
A2	1.17	1.37	0.046	0.054			E1	13.46	-	0.53	-	
b	0.99	1.40	0.039	0.055			е	5.46	BSC	0.215	BSC	
b1	0.99	1.35	0.039	0.053			ØК	0.2	254	0.0)10	
b2	1.65	2.39	0.065	0.094			L	14.20	16.10	0.559	0.634	
b3	1.65	2.34	0.065	0.092			L1	3.71	4.29	0.146	0.169	
b4	2.59	3.43	0.102	0.135			ØР	3.56	3.66	0.14	0.144	
b5	2.59	3.38	0.102	0.133			Ø P1	-	7.39	-	0.291	
С	0.38	0.89	0.015	0.035			Q	5.31	5.69	0.209	0.224	
c1	0.38	0.84	0.015	0.033			R	4.52	5.49	0.178	0.216	
D	19.71	20.70	0.776	0.815	3		S	5.51	BSC	0.217	BSC	
D1	13.08	-	0.515	-	4							

Notes

⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994

(2) Contour of slot optional

(3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

⁽⁴⁾ Thermal pad contour optional with dimensions D1 and E1

⁽⁵⁾ Lead finish uncontrolled in L1

⁽⁶⁾ Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")

⁽⁷⁾ Outline conforms to JEDEC[®] outline TO-247 with exception of dimension c and Q

Revision: 20-Apr-17

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